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Product Change Notification - JAON-09ONJN702 (Printer Friendly)

Date: 20 Oct 2014

CCB 1155.36 Initial Notice: Qualification of palladium coated copper (PdCu) bond wire in selected products of the 90K, 120K, 121K, 150K, Notification subject:

160K, 200K, and 0.25um wafer technologies available in 20L SSOP

Notification text: **PCN Status:**

Initial notification

Microchip Parts Affected:

See attachments of affected catalog part numbers (CPN) labeled as...

PCN_JAON-09ONJN702_Affected_CPN.xls PCN JAON-09ONJN702 Affected CPN.pdf

Description of Change:

Qualification of palladium coated copper (PdCu) bond wire in selected products of the 90K, 120K, 121K, 150K, 160K, 200K, and 0.25um wafer technologies available in 20L SSOP package at MTAI assembly site.

NOTE: Selected products are non-automotive devices. Please review the affected CPN lists (attached) to identify the actual parts affected.

Impacts to Data Sheet:

None

Reason for Change:

To improve manufacturability and qualify PdCu bond wire at MTAI assembly site.

Change Implementation Status:

In Progress

Estimated First Ship Date:

December 19, 2014 (date code: 1451)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Markings to Distinguish Revised from Unrevised Devices:

Traceability code

Revision History:

October 20, 2014: Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s): PCN_JAON-09ONJN702_Qual Plan.pdf

PCN_JAON-09ONJN702_Affected CPN.pdf PCN JAON-09ONJN702 Affected CPN xls

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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